

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.
For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _{RM}	1,000	V
RMS Reverse Voltage	V _{R(RMS)}	700	V
Average Rectified Output Current (@T _A = +75°C)	I _O	1.0	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	25	A

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance, Junction to Case (Note 5)	R _{θJC}	13	°C/W
Thermal Resistance Junction to Ambient (Note 5)	R _{θJA}	78	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 6)	V _{(BR)R}	1,000	—	—	V	I _R = 5μA
Forward Voltage Drop	V _F	—	0.98 0.88	1.1 —	V	I _F = 1A, T _J = +25°C I _F = 1A, T _J = +125°C
Leakage Current (Note 6)	I _R	—	0.2 11	10 100	μA	V _R = 1,000V, T _J = +25°C V _R = 1,000V, T _J = +125°C
Reverse Recovery Time	t _{RR}	—	1.0	—	μs	I _F = 0.5A, I _R = 1.0A, I _{RR} = 0.25A
Total Capacitance	C _T	—	6	—	pF	V _R = 4.0V _{DC} , f = 1MHz

Notes: 5. Device mounted on FR4 PC board, 1 inch x 1 inch, 2oz. copper traces with 1x recommended pad layout per <http://www.diodes.com/package-outlines.html>.
6. Short duration pulse test used to minimize self-heating effect.

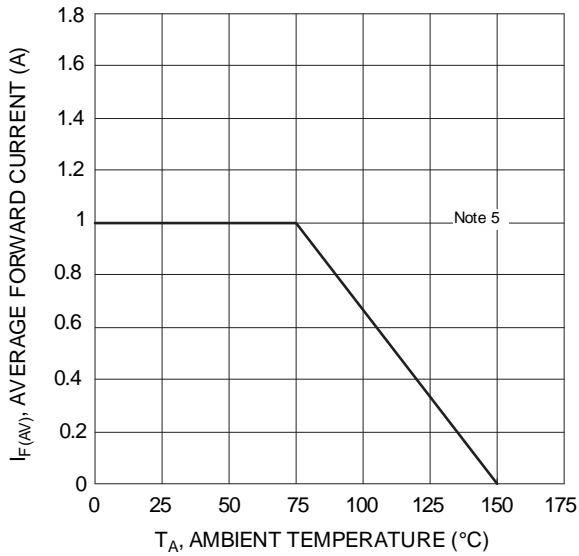


Figure 1 DC Forward Current Derating Curve

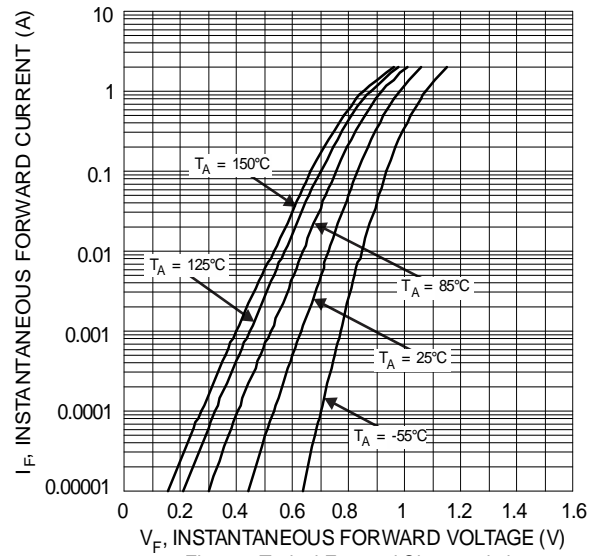


Figure 2 Typical Forward Characteristics

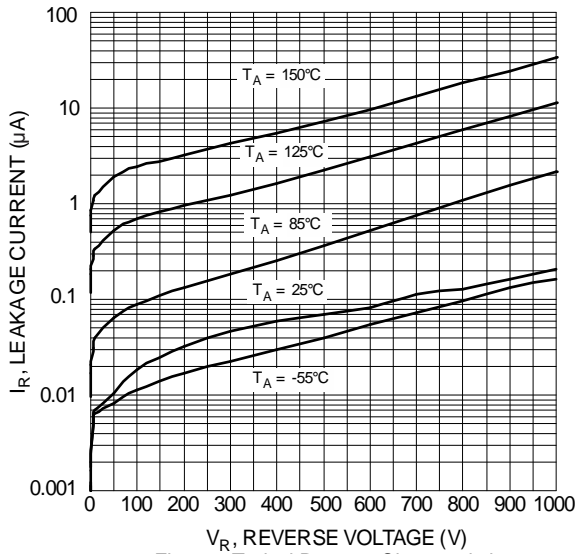


Figure 3 Typical Reverse Characteristics

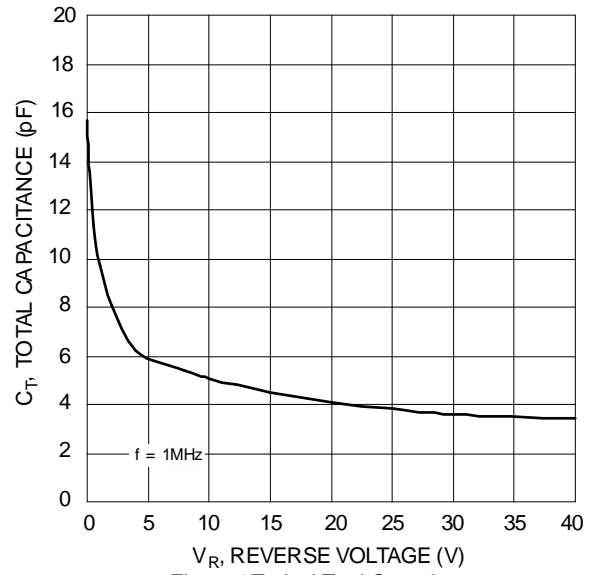
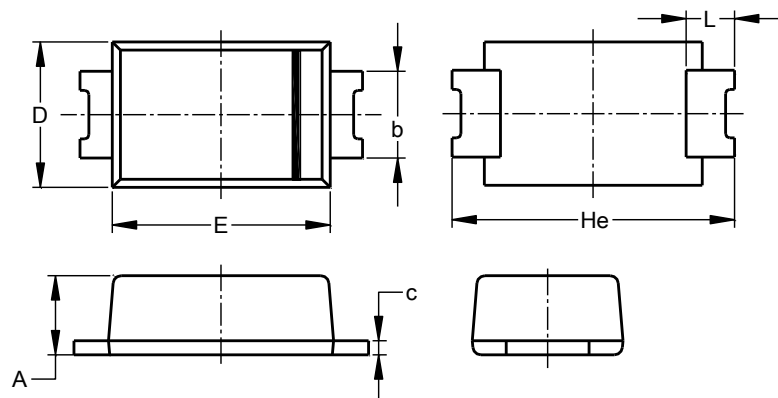


Figure 4 Typical Total Capacitance

Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOD123F (Type B)

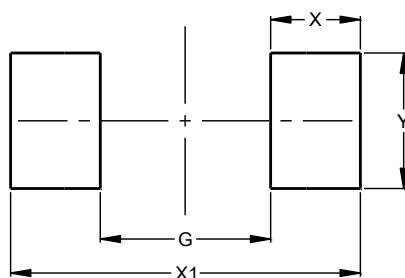


SOD123F (Type B)			
Dim	Min	Max	Typ
A	0.81	1.15	—
b	0.80	1.35	—
c	0.05	0.30	—
D	1.70	1.90	1.80
E	2.60	2.80	2.70
He	3.30	3.70	3.50
L	0.35	0.85	—
All Dimensions in mm			

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOD123F (Type B)



Dimensions	Value (in mm)
G	1.90
X	1.00
X1	3.90
Y	1.50

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